



Customer Information Notification

202104045I : MC9S12ZVMB-Family Reference Manual Update from rev1.4 to rev1.5

Note: This notice is NXP Company Proprietary.

Issue Date: May 14, 2021 **Effective date:** May 15, 2021



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Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Process | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Location | <input type="checkbox"/> Electrical spec./Test coverage |
- Firmware Other: Reference Manual update

PCN Overview

Description

NXP Semiconductors announces Reference Manual update for MC9S12ZVMB-Family from revision 1.4 to revision 1.5. The revision history included in the updated document provides a details description of the changes.

Changes in the document includes:

-Update the Thermal Characteristics table in Section Appendix A, "MCU Electrical Specifications" (Table A-8 and Table A-9).

The MC9S12ZVMB-Family Reference Manual Revision 1.5 is attached to this notification for the summary changes and can be found at :

https://www.nxp.com/products/processors-and-microcontrollers/additional-mpu-mcus-architectures/s12-magniv-mixed-signal-mcus/mixed-signal-mcu-for-automotive-industrial-motor-control-applications:S12ZVMB?tab=Documentation_Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02.

Reason

The reference manual has been updated to provide correction information.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Additional information

Additional documents: [view online](#)

Contact and Support

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For specific questions on this notice or the products affected please contact our specialist directly:

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